

Amendments to the Specification are as follows:

Before the first sentence on page 1 please insert the following paragraph.

This application claims the benefit of priority to International Application No. PCT/JP03/04346 filed on October 23, 2003 and Japanese Patent Application No. 2002-105869 filed on April 8, 2002, herein incorporated by reference.

Please amend page 2, line 5 as follows:

Summary of Invention~~Disclosure of Invention~~

Please amend page 8, line 11 as follows:

Detailed Description~~Best Mode for Carrying Out the Invention~~

Please amend the paragraph beginning on page 15, line 5 and ending on page 15, line 11 as follows:

As shown in Fig. 8, each of the chargers 7 has a built-in antenna 110. The antenna 110 receives high-frequency data signals sent from the IC chip 80 through the antenna 90, and is connected to a control circuit 120. The control circuit 120 is arranged at the backside, i.e. the opposite side of the door 4,3, like an ordinary refrigerator having electrical system circuits at the backside.

Please amend the paragraph beginning on page 15, line 12 and ending on page 16, line 8 as follows:

The control circuit 120 processes the data signals received by the antenna 110 and drives a charger 7, which outputs electromagnetic waves in the optimal direction in relation to the object W, among the four chargers 7 around the object W. In particular, each of the four chargers 7 around the object W communicates with the high-frequency IC chip 80 in turn at a predetermined interval. A charger 7 that fails to communicate is not used. Therefore, based upon whether or not these four chargers 7 are used, it can be confirmed whether the object W is put in. When more than one charger 7 are in communication with the high-frequency IC chip 80, thea charger 7 inwhich shows an optimal communication with the object W is used for

receiver of the object W. The chargers 7 include a means for detecting receiving sensitivity (not shown). The optimal direction of the electromagnetic waves differs depending on the charging condition of the chargers 7, and is determined from various conditions. For example, depending on the high frequency data signals from the IC chip 80, a charger 7 having the coil of the power feeder closest to the coil 41 of the power receiver of the object W is driven, and then charges the object W.

Please amend the paragraph beginning on page 22, line 21 and ending on page 23, line 3 as follows:

The charging apparatus 301 is particularly useful in charging an object W of medium size or in simultaneously charging multiple objects W of medium or small size by merely putting them in the housing ~~302~~²⁰² at random. Each of the objects W is provided with a rectangular board 100 or a circular board 150 having the IC chip 80 and the antenna 90 shown in Figs. 6 and 7, before the object W is put in the housing 302.

Please amend the paragraph beginning on page 23, line 23 and ending on page 24, line 9 as follows:

The inner part of the housing 402 is divided into four segments by standing partitions 406. The housing 402 has chargers 407 larger than the chargers 7 shown in Figs. 2 and 3 embedded in the inner faces of the side walls and the inner face of the bottom of the housing 402. The partitions 406 consist of a partition 406a in the longitudinal direction and a partition 406~~b~~_a in the width direction. The chargers 407 are mounted on both sides of the partition 406a in the longitudinal direction. These chargers 407 have the same structure as the chargers 7 shown in Figs. 2, 3, 4, and 8. In Fig. 16, reference numeral 409 represents shielding bodies built in the partitions 406a and 406b.

Please amend the paragraph beginning on page 24, line 10 and ending on page 24, line 17 as follows:

The charging apparatus 401 is particularly useful in charging an object W of relatively small size or in simultaneously charging multiple objects W of small size by merely putting them in the housing ~~402~~²⁰² at random. Each of the objects W is provided with a rectangular board 100 or a circular board 150 having the IC chip 80 and the antenna 90 shown in Figs. 6 and 7, before the object W is put in the housing ~~402~~³⁰².

Please amend page 24, line 19 as follows:

~~Industrial Applicability~~